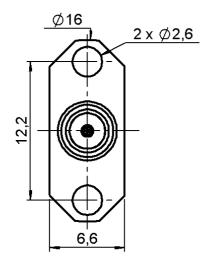
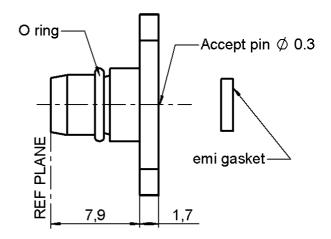
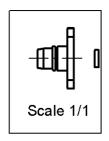
FOR 0.3MM AXIS WITH EMI GASKET

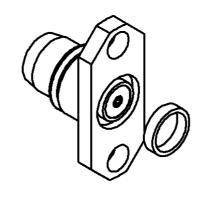
R128.481.001

Series: BMA









All dimensions are in mm.

$-(\Omega)$

COMPONENTS	MATERIALS	PLATINGS (µm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	STAINLESS STEEL BERYLLIUM COPPER - PTFE SILICONE CuAg(conductor) -	PASSIVATED . GOLD 1.3 OVER NICKEL 2 -
-	-	-

Issue: 0448 A



FOR 0.3MM AXIS WITH EMI GASKET

R128.481.001

Series: BMA

PACKAGING

Standard	Unit	Other
1	•	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} \;\; \Omega \\ \text{Frequency} & & \textbf{0-22} \;\; \text{GHz} \end{array}$

VSWR 1.06 + 0.010 x F(GHz) Maxi

Insertion loss $0.03 \sqrt{F(GHz)}$ Maxi

RF leakage - (NA - F(GHz)) dB Maxi
Voltage rating 350 Veff Maxi
Dielectric withstanding voltage 1000 Veff mini

Dielectric withstanding voltage Insulation resistance 1000 Veff mini 5000 M Ω mini

ENVIRONMENTAL

Operating temperature -65/+105 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction NA

Others:

Mount it with R280.751.000 glass bead for hermetic application (see page 3&4)

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

27 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 1000 Cycles mini

Weight **0.000** g

Issue: 0448 A

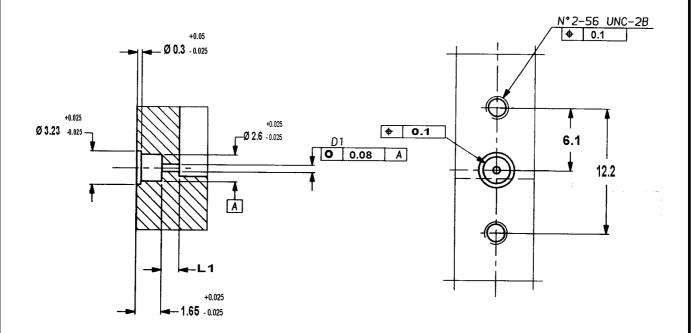


FOR 0.3MM AXIS WITH EMI GASKET

R128.481.001

Series: BMA

RECOMMENDED MOUTING HOLE DETAIL



D1 and L1 dimensions have to be determined according to each application.

We advise of the two following cases (see page 4)

- using of the the R280.469.000 removable socket:

$$D1=2 + / -0.02$$

- the glass bead axis is directly welded on the track:

D1 = 0.70 + -0.02

L1 = from 1 to 4 according to the customer's design criteria

Issue: 0448 A

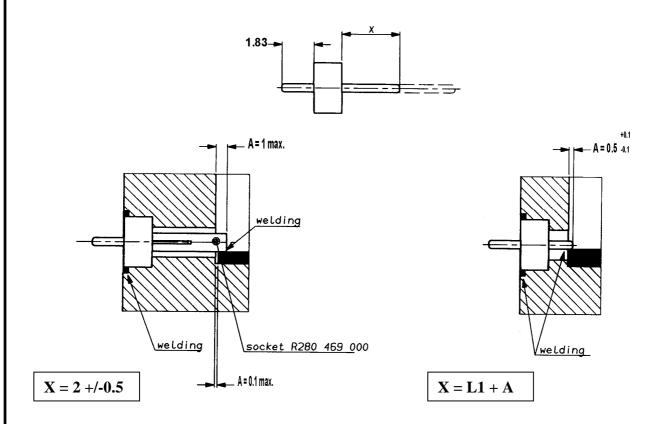


FOR 0.3MM AXIS WITH EMI GASKET

R128.481.001

Series: BMA

ASSEMBLY INSTRUCTIONS



GLASS BEAD

- adjust X by cutting the pin if necessary
- introduce the glass bead into its housing as here above (with the mounted socket)
- weld the ring by putting a welding wire in the groove
- weld the pin (or socket) on the track. Beware of putting too much welding!

<u>Important</u>: for maximum RF characteristics the link track/pin must be as thin as possible. We advise you respect rigourously the dimension A, by welding accuratly the bead pin directly on the track (right drawing).

CONNECTOR

- set up the « EMI » screening gasket in the connector groove.
- Put the connector on the housing while introducing the bead pin into the socket, then mount the fixtures of the flange.

Issue: 0448 A

